onsemi

MOSFET - Power, Single N-Channel, STD Gate, SO8-FL

40 V, 0.7 mΩ**, 323 A**

NVMFWS0D7N04XM

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Small Footprint (5 x 6 mm) with Compact Design
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Motor Drive
- Battery Protection
- Synchronous Rectification

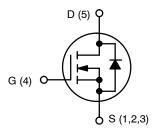
MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage	V _{DSS}	40	V	
Gate-to-Source Voltage	V _{GS}	±20	V	
Continuous Drain Current	$T_{C} = 25^{\circ}C$	۱ _D	323	А
	$T_{C} = 100^{\circ}C$	1	229	
Power Dissipation	$T_{C} = 25^{\circ}C$	PD	134	W
Continuous Drain Current	$T_A = 25^{\circ}C$	I _{DA}	9.18	А
	$T_A = 100^{\circ}C$		6.49	
Pulsed Drain Current	$T_{\rm C} = 25^{\circ}{\rm C},$	I _{DM}	900	А
Pulsed Source Current (Body Diode)	t _p = 10 μs	I _{SM}	900	A
Operating Junction and Stora Range	T _J , T _{STG}	–55 to 175	°C	
Source Current (Body Diode)		۱ _S	202	А
Single Pulse Avalanche Energy (I_{PK} = 21 A)		E _{AS}	987	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
40 V	$0.7~\mathrm{m}\Omega$	323 A

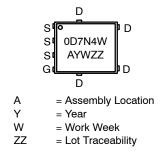
N-CHANNEL MOSFET





DFNW5 (SO-8FL) CASE 507BA

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

THERMAL CHARACTERISTICS

Reverse Recovery Charge

Parameter		Value	Unit
Thermal Resistance, Junction-to-Case (Note 2)		1.11	°C/W
Thermal Resistance, Junction-to-Ambient (Notes 1, 2)	R_{\thetaJA}	39.3	

1. Surface-mounted on FR4 board using 650 mm² pad, 2 oz Cu pad.

2. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A	40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS} / \Delta T_J$	I_D = 250 µA, Referenced to 25°C		14.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 40 V, T_J = 25°C			1	μΑ
		V_{DS} = 40 V, T_J = 125°C			40	
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 50 A		0.59	0.7	mΩ
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 180 μ A	2.5	3.0	3.5	V
Gate Threshold Voltage Temperature Coefficient	$\Delta V_{GS(TH)}/ \Delta T_J$	V_{GS} = V_{DS} , I_D = 180 μ A		-7.2		mV/°C
Forward Trans-conductance	9 FS	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 50 \text{ A}$		244		S
CHARGES, CAPACITANCES & GATE RE	ESISTANCE					
Input Capacitance	C _{ISS}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		4595		pF
Output Capacitance	C _{OSS}			2980]
Reverse Transfer Capacitance	C _{RSS}			41.8		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DD} = 32 V; I_{D} = 50 A		71.6		nC
Threshold Gate Charge	Q _{G(TH)}			13.5		
Gate-to-Source Charge	Q _{GS}			20.6		
Gate-to-Drain Charge	Q _{GD}			13		1
Gate Resistance	R _G	f = 1 MHz		0.69		Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = 0/10 \text{ V}, V_{DD} = 32 \text{ V},$		7.33		ns
Rise Time	t _r	$I_D = 50 \text{ A}, \text{ R}_G = 0 \Omega$		5.39		
Turn-Off Delay Time	t _{d(OFF)}			11.1		
Fall Time	t _f			4.48		
SOURCE TO DRAIN DIODE CHARACTE	RISTICS	•				
Forward Diode Voltage	V _{SD}	V_{SD} $V_{GS} = 0 V,$ $T_{J} = 25^{\circ}C$ 0.81 1	1.2	V		
		I _S = 50 A T _J = 125°C		0.66		
Reverse Recovery Time	t _{RR}	$V_{DD} = 32 \text{ V}, \text{ I}_{\text{F}} = 50 \text{ A},$		94.4		ns
Charge Time	t _a	dl/dt = 100 A/μs		55.6		
Discharge Time	t _b	1		38.8		
				1		1

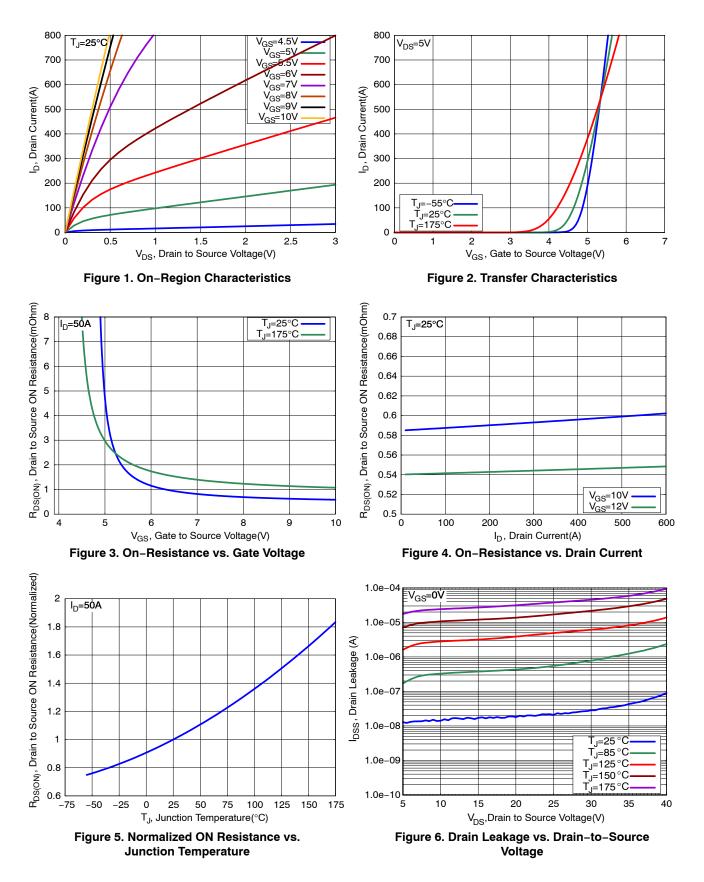
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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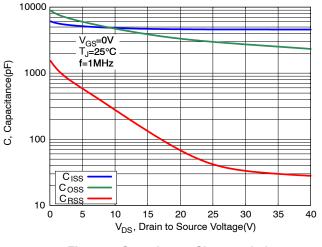
nC

Q_{RR}

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





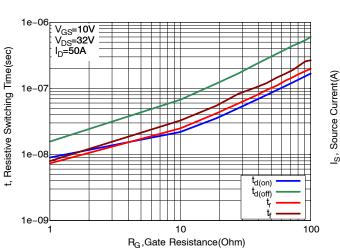
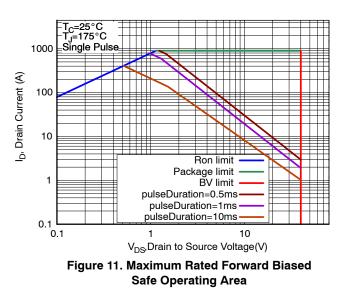


Figure 9. Resistive Switching Time Variation vs. Gate Resistance



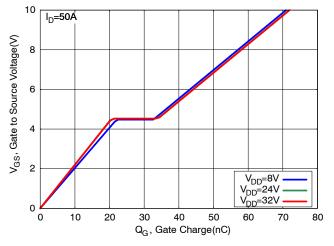


Figure 8. Gate Charge Characteristics

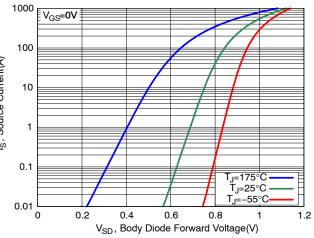


Figure 10. Diode Forward Characteristics

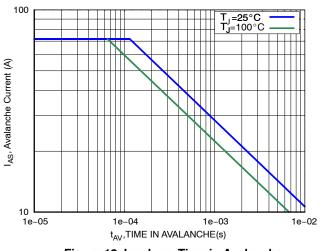


Figure 12. Ipeak vs. Time in Avalanche

TYPICAL CHARACTERISTICS

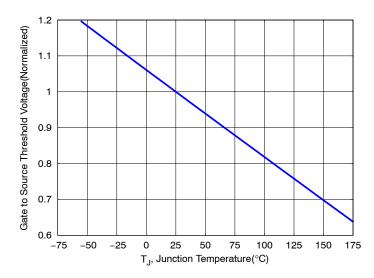
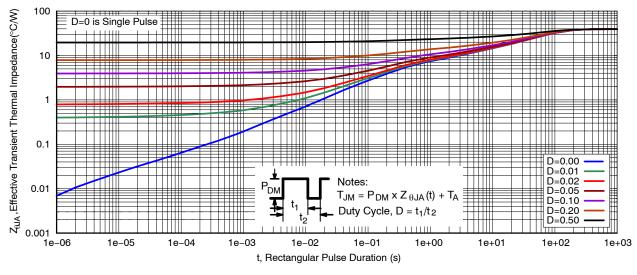


Figure 13. Gate Threshold Voltage vs. Junction Temperature



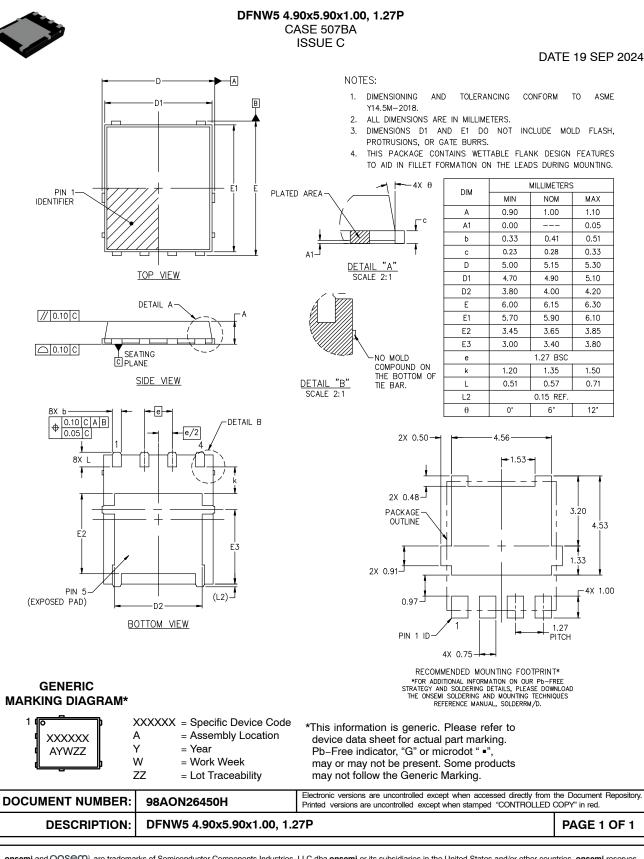


ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFWS0D7N04XMT1G	0D7N4W	DFNW5 (Pb–Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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